

查询"MRF20030R_D"供应商

The RF Sub-Micron Bipolar Line

RF Power Bipolar Transistor

Designed for broadband commercial and industrial applications at frequencies from 1800 to 2000 MHz. The high gain and broadband performance of this device makes it ideal for large-signal, common-emitter class AB amplifier applications. Suitable for frequency modulated, amplitude modulated and multi-carrier base station RF power amplifiers.

- Specified 26 Volts, 2.0 GHz, Class AB, Two-Tones Characteristics
 - Output Power — 30 Watts (PEP)
 - Power Gain — 9.8 dB
 - Efficiency — 34%
 - Intermodulation Distortion — -28 dBc
- Typical 26 Volts, 1.88 GHz, Class AB, CW Characteristics
 - Output Power — 30 Watts
 - Power Gain — 11 dB
 - Efficiency — 40%
 - Intermodulation Distortion — -30 dBc
- Excellent Thermal Stability
- Capable of Handling 3:1 VSWR @ 26 Vdc, 2000 MHz, 30 Watts (PEP) Output Power
- Characterized with Series Equivalent Large-Signal Impedance Parameters
- S-Parameter Characterization at High Bias Levels
- Designed for FM, TDMA, CDMA, and Multi-Carrier Applications

Note: Not suitable for class A operation.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	25	Vdc
Collector-Emitter Voltage	V_{CES}	60	Vdc
Collector-Base Voltage	V_{CBO}	60	Vdc
Collector-Emitter Voltage ($R_{BE} = 100 \Omega$)	V_{CER}	30	Vdc
Emitter-Base Voltage	V_{EB}	-3	Vdc
Collector Current - Continuous	I_C	4	Adc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	125 0.71	Watts W/ $^\circ\text{C}$
Storage Temperature Range	T_{stg}	-65 to +150	$^\circ\text{C}$
Operating Junction Temperature	T_J	200	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Thermal Resistance, Junction to Case ⁽¹⁾	$R_{\theta JC}$	1.4	$^\circ\text{C/W}$

(1) Thermal resistance is determined under specified RF operating condition.

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

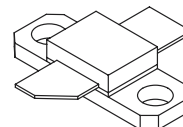
Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage ($I_C = 25 \text{ mAdc}$, $I_B = 0$)	$V_{(BR)CEO}$	25	28	—	Vdc
Collector-Emitter Breakdown Voltage ($I_C = 25 \text{ mAdc}$, $V_{BE} = 0$)	$V_{(BR)CES}$	60	70	—	Vdc
Collector-Base Breakdown Voltage ($I_C = 25 \text{ mAdc}$, $I_E = 0$)	$V_{(BR)CBO}$	60	70	—	Vdc

MRF20030R

30 W, 2.0 GHz
NPN SILICON
BROADBAND
RF POWER TRANSISTOR



CASE 395C-01, STYLE 1



ELECTRICAL CHARACTERISTICS — continued ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Emitter–Base Breakdown Voltage ($I_B = 5\text{ mA}$, $I_C = 0$)	$V_{(BR)EBO}$	3	3.8	—	Vdc
Collector Cutoff Current ($V_{CE} = 30\text{ Vdc}$, $V_{BE} = 0$)	I_{CES}	—	—	10	mA

ON CHARACTERISTICS

DC Current Gain ($V_{CE} = 5\text{ Vdc}$, $I_{CE} = 1\text{ A}$)	h_{FE}	20	40	80	—
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DYNAMIC CHARACTERISTICS

Output Capacitance ($V_{CB} = 26\text{ Vdc}$, $I_E = 0$, $f = 1.0\text{ MHz}$) ⁽¹⁾	C_{ob}	—	28	—	pF
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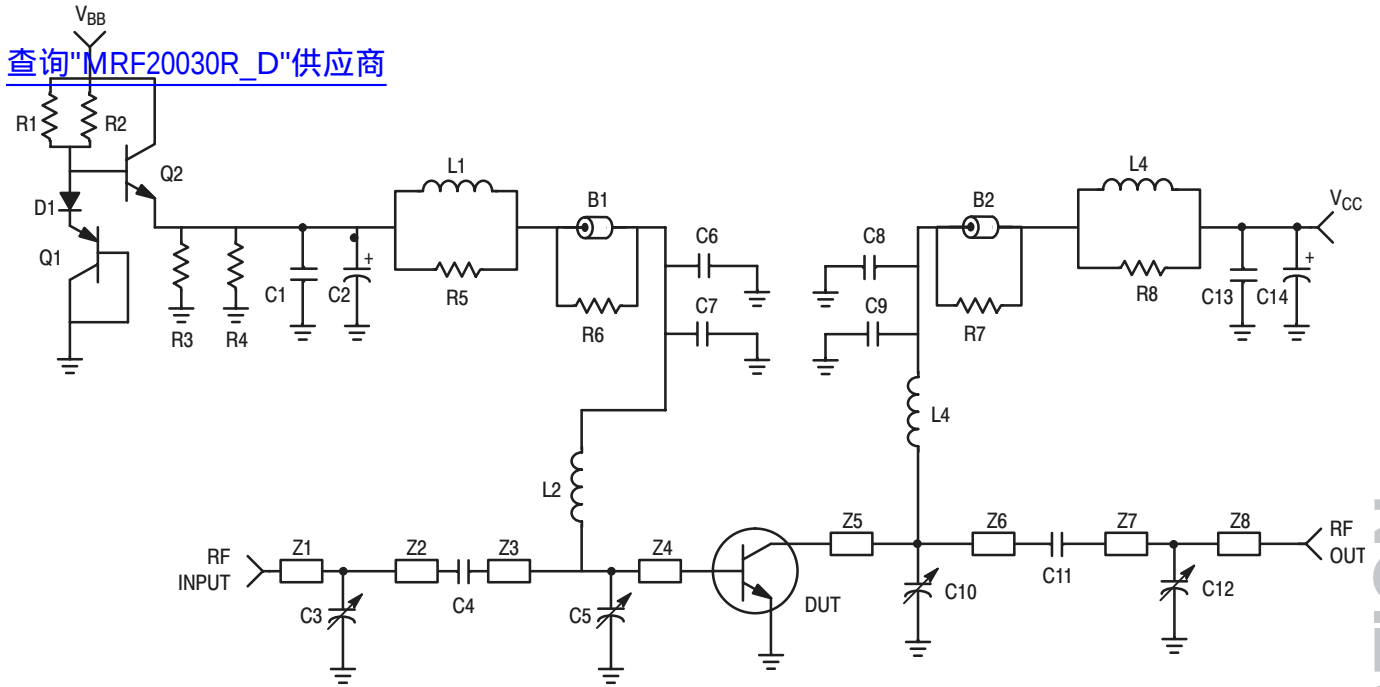
FUNCTIONAL TESTS (In Motorola Test Fixture)

Common–Emitter Amplifier Power Gain ($V_{CC} = 26\text{ Vdc}$, $P_{out} = 30\text{ Watts}$, $I_{CQ} = 120\text{ mA}$, $f_1 = 2000.0\text{ MHz}$, $f_2 = 2000.1\text{ MHz}$)	G_{pe}	9.8	11	—	dB
Collector Efficiency ($V_{CC} = 26\text{ Vdc}$, $P_{out} = 30\text{ Watts (PEP)}$, $I_{CQ} = 120\text{ mA}$, $f_1 = 2000.0\text{ MHz}$, $f_2 = 2000.1\text{ MHz}$)	η	34	38	—	%
Intermodulation Distortion ($V_{CC} = 26\text{ Vdc}$, $P_{out} = 30\text{ Watts (PEP)}$, $I_{CQ} = 120\text{ mA}$, $f_1 = 2000.0\text{ MHz}$, $f_2 = 2000.1\text{ MHz}$)	IMD	—	– 30	– 28	dBc
Input Return Loss ($V_{CC} = 26\text{ Vdc}$, $P_{out} = 30\text{ Watts (PEP)}$, $I_{CQ} = 125\text{ mA}$, $f_1 = 2000.0\text{ MHz}$, $f_2 = 2000.1\text{ MHz}$)	IRL	10	17	—	dB
Load Mismatch ($V_{CC} = 26\text{ Vdc}$, $P_{out} = 30\text{ Watts (PEP)}$, $I_{CQ} = 120\text{ mA}$, $f_1 = 2000.0\text{ MHz}$, $f_2 = 2000.1\text{ MHz}$, Load VSWR = 3:1, All Phase Angles at Frequency of Test)	ψ	No Degradation in Output Power			
Common–Emitter Amplifier Power Gain ($V_{CC} = 26\text{ Vdc}$, $P_{out} = 30\text{ Watts (PEP)}$, $I_{CQ} = 125\text{ mA}$, $f_1 = 1930.0\text{ MHz}$, $f_2 = 1930.1\text{ MHz}$)	G_{pe}	—	11	—	dB
Collector Efficiency ($V_{CC} = 26\text{ Vdc}$, $P_{out} = 30\text{ Watts (PEP)}$, $I_{CQ} = 125\text{ mA}$, $f_1 = 1930.0\text{ MHz}$, $f_2 = 1930.1\text{ MHz}$)	η	—	34	—	%
Intermodulation Distortion ($V_{CC} = 26\text{ Vdc}$, $P_{out} = 30\text{ Watts (PEP)}$, $I_{CQ} = 125\text{ mA}$, $f_1 = 1930.0\text{ MHz}$, $f_2 = 1930.1\text{ MHz}$)	IMD	—	– 32	—	dBc
Input Return Loss ($V_{CC} = 26\text{ Vdc}$, $P_{out} = 30\text{ Watts (PEP)}$, $I_{CQ} = 125\text{ mA}$, $f_1 = 1930.0\text{ MHz}$, $f_2 = 1930.1\text{ MHz}$)	IRL	—	14	—	dB

GUARANTEED BUT NOT TESTED (In Motorola Test Fixture)

Common–Emitter Amplifier Power Gain ($V_{CC} = 26\text{ Vdc}$, $P_{out} = 30\text{ Watts}$, $I_{CQ} = 125\text{ mA}$, $f = 1880\text{ MHz}$)	G_{pe}	—	10.5	—	dB
Collector Efficiency ($V_{CC} = 26\text{ Vdc}$, $P_{out} = 30\text{ Watts}$, $I_{CQ} = 125\text{ mA}$, $f = 1880\text{ MHz}$)	η	—	40	—	%
Input Return Loss ($V_{CC} = 26\text{ Vdc}$, $P_{out} = 30\text{ Watts}$, $I_{CQ} = 125\text{ mA}$, $f = 1880\text{ MHz}$)	IRL	—	14	—	dB
Output Mismatch Stress ($V_{CC} = 25\text{ Vdc}$, $P_{out} = 30\text{ Watts}$, $I_{CQ} = 125\text{ mA}$, $f = 1880\text{ MHz}$, VSWR = 3:1, All Phase Angles at Frequency of Test)	ψ	Typically No Degradation in Output Power			

(1) For Information Only. This Part Is Collector Matched.



B1, B2	Ferrite Bead, P/N 5659065/3B, Ferroxcube	N1, N2	Type N Flange Mount RF Connector
C1, C13	0.1 μ F, Chip Capacitor, Kermet	R1, R2	MA/COM 3052-1648-10
C2	100 μ F, 50 V, Electrolytic Capacitor, Mallory	R3, R4	130 Ω , 1/8 W Chip Resistor, Rohm
C3, C5, C12	0.6-4 pF, Variable Capacitor, Johanson, Gigatrim	R5, R8	100 Ω , 1/8 W Chip Resistor, Rohm
C4, C11	10 pF, B Case Chip Capacitor, ATC	R6, R7	10 Ω , 1/2 W Resistor
C6, C8	24 pF, B Case Chip Capacitor, ATC	Q1	10 Ω , 1/8 W Chip Resistor, Rohm (10J)
C7, C9	75 pF, B Case Chip Capacitor, ATC	Q2	Transistor, PNP Motorola (BD136)
C10	0.4-2.5 pF, Variable Capacitor, Johanson, Gigatrim	Board	Transistor, NPN Motorola (MJD47)
C14	470 μ F, 63 V, Electrolytic Capacitor, Mallory		30 Mil Glass Teflon [®] , Arlon GX-0300-55-22,
D1	Diode, Motorola (MUR3160T3)		$\epsilon_r = 2.55$
L1, L4	12 Turns, 22 AWG, IDIA. 0.195"		
L2, L3	0.750" 20 AWG		

Figure 1. Class AB Test Fixture Electrical Schematic

TYPICAL CHARACTERISTICS

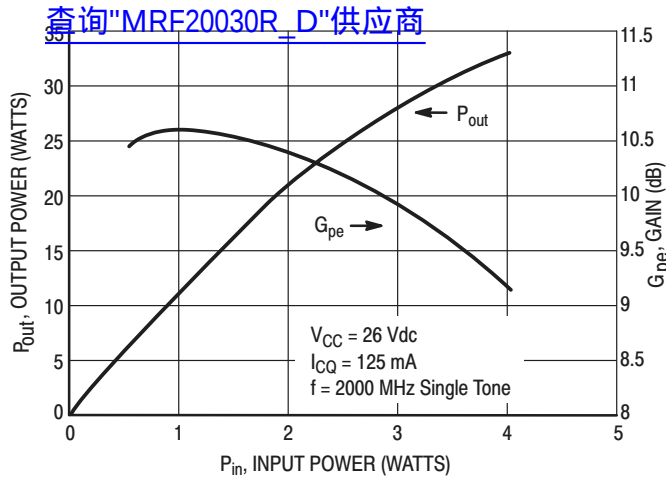


Figure 2. Output Power & Power Gain versus Input Power

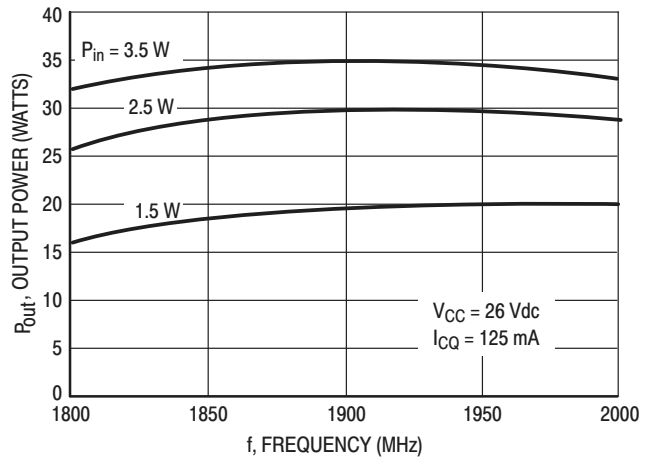


Figure 3. Output Power versus Frequency

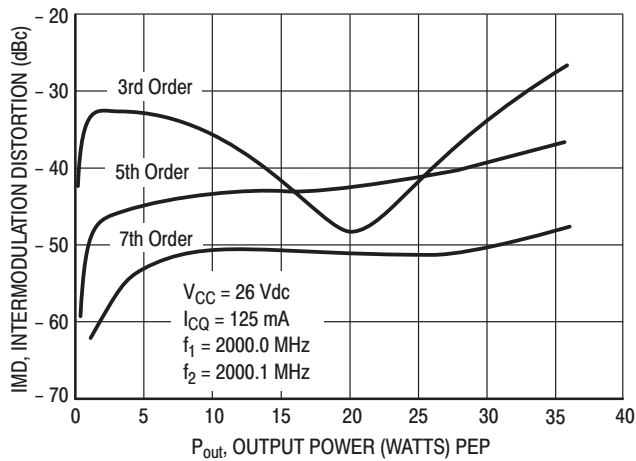


Figure 4. Intermodulation Distortion versus Output Power

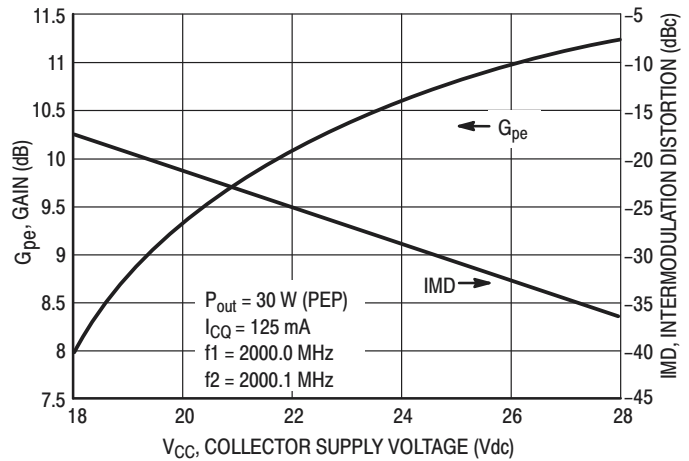


Figure 5. Power Gain and Intermodulation Distortion versus Supply Voltage

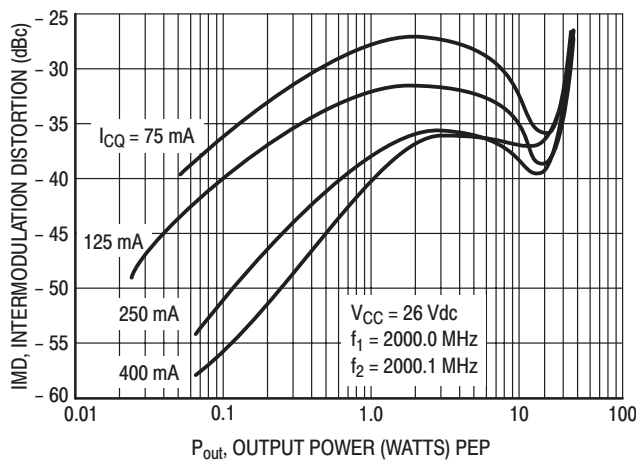


Figure 6. Intermodulation Distortion versus Output Power

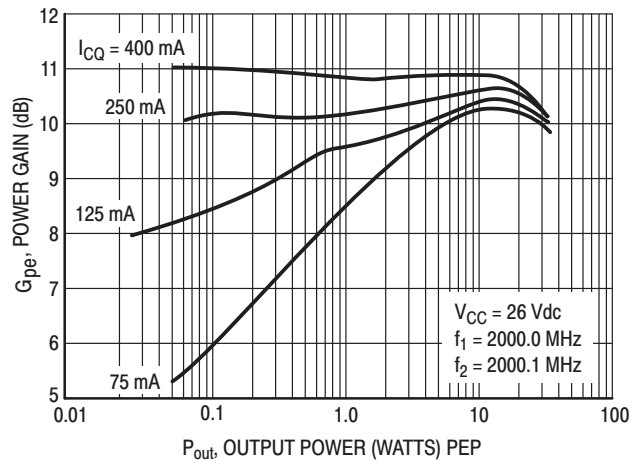


Figure 7. Power Gain versus Output Power

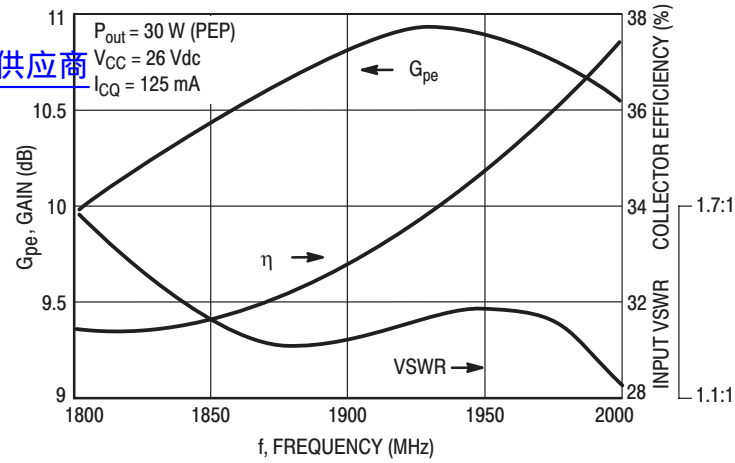
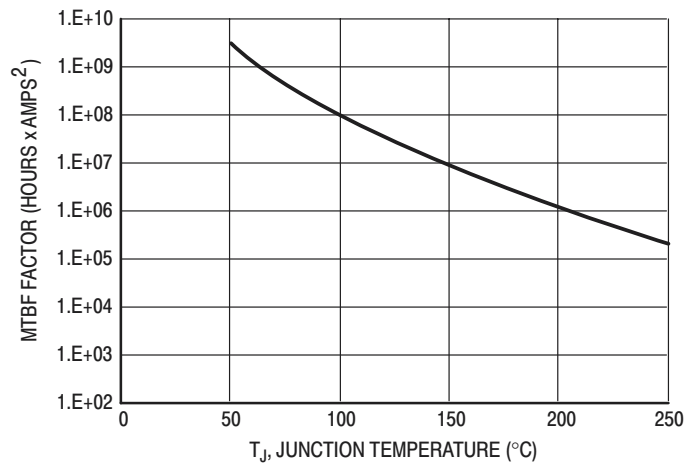
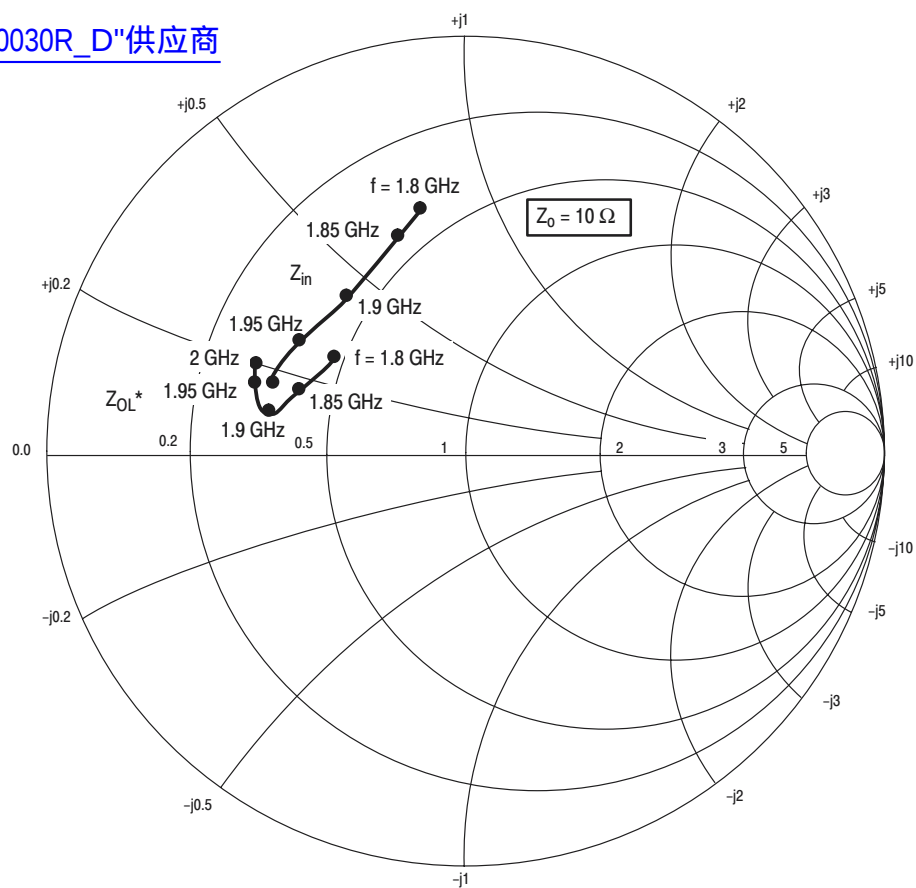


Figure 8. Performance in Broadband Circuit



This above graph displays calculated MTBF in hours x ampere² emitter current. Life tests at elevated temperatures have correlated to better than $\pm 10\%$ of the theoretical prediction for metal failure. Divide MTBF factor by I_C^2 for MTBF in a particular application.

Figure 9. MTBF Factor versus Junction Temperature



$V_{CC} = 26 \text{ V}$, $I_{CQ} = 125 \text{ mA}$, $P_{out} = 30 \text{ W (PEP)}$

f MHz	$Z_{in}(1)$ Ω	Z_{OL}^* Ω
1800	$4.5 + j7.0$	$4.7 + j2.4$
1850	$4.5 + j6.0$	$4.4 + j1.6$
1900	$4.5 + j4.6$	$3.4 + j1.2$
1950	$3.7 + j2.4$	$3.3 + j1.6$
2000	$3.5 + j1.5$	$3.5 + j2.0$

$Z_{in}(1)$ = Conjugate of fixture base impedance.

Z_{OL}^* = Conjugate of the optimum load impedance at given output power, voltage, bias current and frequency.

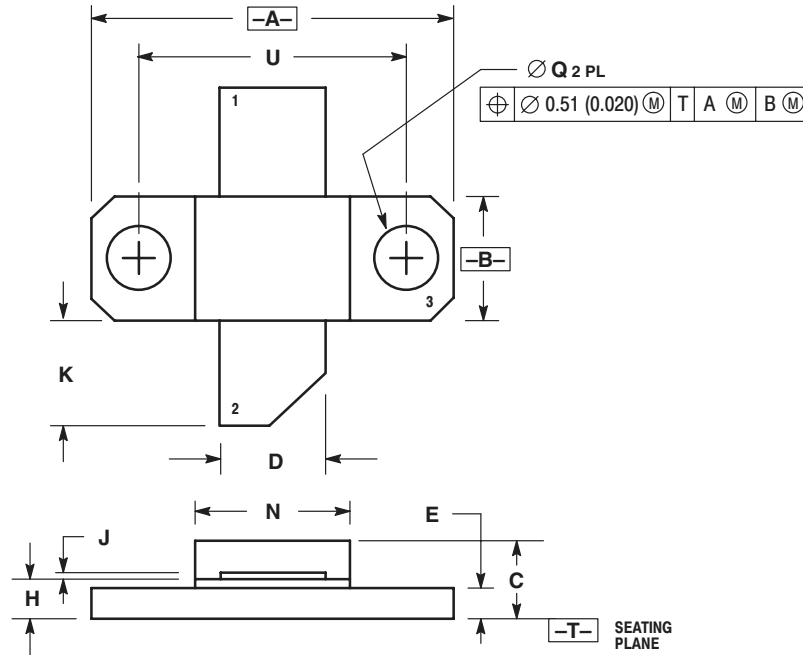
Figure 10. Series Equivalent Input and Output Impedance

Table 1. Common Emitter S-Parameters at $V_{CE} = 24 \text{ Vdc}$, $I_C = 1.8 \text{ Adc}$ [查询"MRF20030R_D"供应商](#)

GHz	S ₁₁		S ₂₁		S ₁₂		S ₂₂	
	S ₁₁	∠ φ	S ₂₁	∠ φ	S ₁₂	∠ φ	S ₂₂	∠ φ
1.5	.964	158	.65	74	.046	60	.859	161
1.55	.960	156	.74	68	.047	56	.841	161
1.6	.952	155	.87	60	.049	53	.815	160
1.65	.933	153	1.05	50	.048	46	.787	161
1.7	.892	149	1.32	35	.047	40	.744	163
1.75	.804	149	1.64	13	.040	29	.719	168
1.8	.727	157	1.78	-18	.026	21	.778	175
1.85	.787	163	1.50	-50	.015	54	.883	174
1.9	.873	163	1.14	-73	.020	81	.937	171
1.95	.921	160	.84	-89	.026	88	.949	168
2	.941	157	.62	-102	.031	93	.950	165
2.05	.943	155	.48	-109	.036	93	.946	164
2.1	.940	153	.38	-118	.040	92	.942	163
2.15	.928	151	.30	-127	.042	97	.939	162
2.2	.917	150	.24	-133	.049	99	.935	161
2.25	.907	150	.20	-140	.056	101	.933	160
2.3	.888	148	.17	-150	.066	100	.926	159
2.35	.861	148	.14	-159	.077	98	.916	157
2.4	.853	149	.11	-167	.087	92	.909	157
2.45	.860	146	.10	-176	.095	89	.900	155
2.5	.880	146	.10	156	.119	84	.880	155

PACKAGE DIMENSIONS

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NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.739	0.750	18.77	19.05
B	0.240	0.260	6.10	6.60
C	0.165	0.198	4.19	5.03
D	0.215	0.225	5.46	5.72
E	0.055	0.070	1.40	1.78
H	0.079	0.091	2.01	2.31
J	0.004	0.006	0.10	0.15
K	0.210	0.240	5.33	6.10
N	0.315	0.330	8.00	8.38
Q	0.125	0.135	3.18	3.42
U	0.560 BSC		14.23 BSC	

STYLE 1:
PIN 1: BASE
2: COLLECTOR
3: EMITTER

**CASE 395C-01
ISSUE A**

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